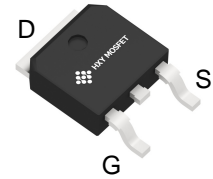




## Description

The RFD3055LESM9A uses advanced trench technology to provide excellent  $R_{DS(ON)}$ , low gate charge and operation with gate voltages as low as 4.5V. This device is suitable for use as a Battery protection or in other Switching application.



TO-252-2L  
(DPAK)

## General Features

$V_{DS} = 60V$   $I_D = 8A$

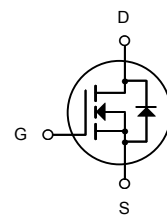
$R_{DS(ON)} < 100m\Omega$  @  $V_{GS}=10V$

## Application

Battery protection

Load switch

Uninterruptible power supply



N-Channel MOSFET

## Ordering Information

Product ID	Pack	Brand	Qty(PCS)
RFD3055LESM9A	TO-252-2L(DPAK)	HXY MOSFET	2500

## Absolute Maximum Ratings ( $T_C=25^\circ C$ unless otherwise noted)

Symbol	Parameter	Rating	Units
$V_{DS}$	Drain-Source Voltage	60	V
$V_{GS}$	Gate-Source Voltage	$\pm 20$	V
$I_D@T_C=25^\circ C$	Continuous Drain Current, $V_{GS}$ @ 10V	8	A
$I_D@T_C=100^\circ C$	Continuous Drain Current, $V_{GS}$ @ 10V	4	A
$I_{DM}$	Pulsed Drain Current	24	A
EAS	Single Pulse Avalanche Energy	6	mJ
$P_D@T_C=25^\circ C$	Total Power Dissipation	16	W
$T_{STG}$	Storage Temperature Range	-55 to 150	$^\circ C$
$T_J$	Operating Junction Temperature Range	-55 to 150	$^\circ C$



**Electrical Characteristics (T<sub>J</sub> = 25°C, unless otherwise noted)**

Symbol	Parameter	Conditions	Min	Typ	Max	Units
<b>BV<sub>DSS</sub></b>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V, I <sub>D</sub> =250μA	60	---	---	V
<b>I<sub>DSS</sub></b>	Zero Gate Voltage Drain Current	V <sub>GS</sub> =0V, V <sub>DS</sub> =60V	---	---	1	μA
<b>I<sub>GSS</sub></b>	Gate-Source Leakage Current	V <sub>GS</sub> =±20V, V <sub>DS</sub> =0A	---	---	±100	nA
<b>V<sub>GS(th)</sub></b>	GATE-Source Threshold Voltage	V <sub>GS</sub> =V <sub>DS</sub> , I <sub>D</sub> =250μA	1	1.5	2.2	V
<b>R<sub>DS(on)</sub></b>	Drain-Source On Resistance <sup>2</sup>	V <sub>GS</sub> =10V, I <sub>D</sub> =3A	---	88	100	mΩ
		V <sub>GS</sub> =4.5V, I <sub>D</sub> =2A	---	95	125	mΩ
<b>C<sub>iss</sub></b>	Input Capacitance	V <sub>DS</sub> =25V, V <sub>GS</sub> =0V, f=1MHz	---	349	---	pF
<b>C<sub>oss</sub></b>	Output Capacitance		---	28	--	
<b>C<sub>rss</sub></b>	Reverse Transfer Capacitance		---	22	---	
<b>t<sub>d(on)</sub></b>	Turn-On Delay Time	V <sub>DS</sub> =40V, I <sub>D</sub> =40A, R <sub>ENG</sub> =6Ω, V <sub>GS</sub> =1	---	27	---	ns
<b>t<sub>r</sub></b>	Rise Time		---	17	---	ns
<b>t<sub>d(off)</sub></b>	Turn-Off Delay Time		---	43	---	ns
<b>t<sub>f</sub></b>	Fall Time		---	54	---	ns
<b>Q<sub>gs</sub></b>	Total Gate Charge	0V	---	1	---	nc
<b>Q<sub>gd</sub></b>	Gate-Source Charge	V <sub>GS</sub> =10V,	---	1.4	---	nc
<b>Q<sub>g</sub></b>	Gate-Drain "Miller" Charge	V <sub>DS</sub> =30V, I <sub>D</sub> =3A	---	8	---	nc
<b>V<sub>SD</sub></b>	Diode Forward Voltage <sup>1</sup>	V <sub>GS</sub> =0V, I <sub>SD</sub> =5A	---	---	1.2	V
<b>I<sub>S</sub></b>	Continuous Drain Curren <sup>3</sup>	VD=VG=0V	---	---	8	A
<b>I<sub>SM</sub></b>	Pulsed Drain Current		---	---	24	A

**Notes:**

1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature
2. EAS condition : T<sub>J</sub>=25°C, V<sub>DD</sub>=30V, V<sub>G</sub>=10V, L=0.5mH, R<sub>g</sub>=25Ω, I<sub>AS</sub>=4A
3. Pulse Test: Pulse Width≤300μs, Duty Cycle≤0.5%



### Typical Characteristics

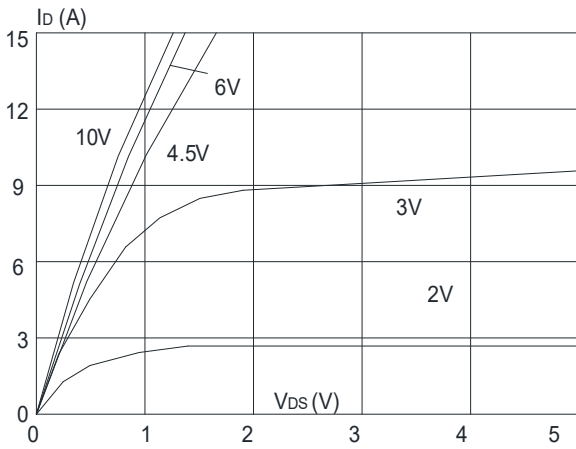


Figure 1: Output Characteristics

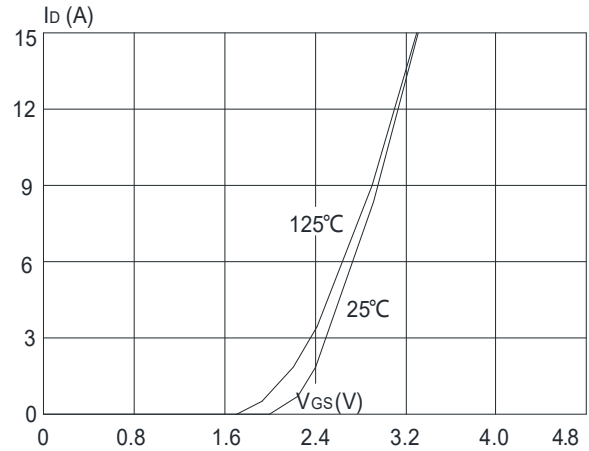


Figure 2: Typical Transfer Characteristics

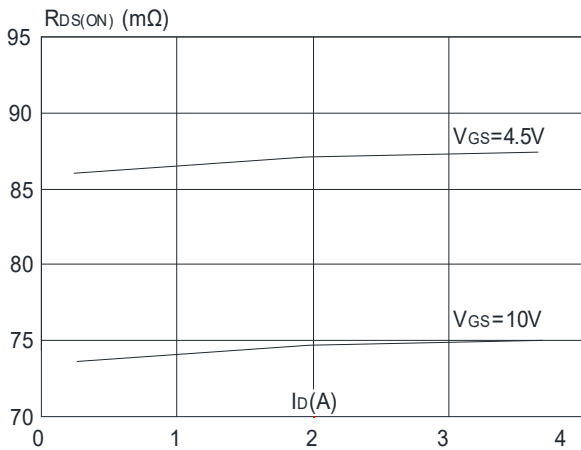


Figure 3: On-resistance vs. Drain Current

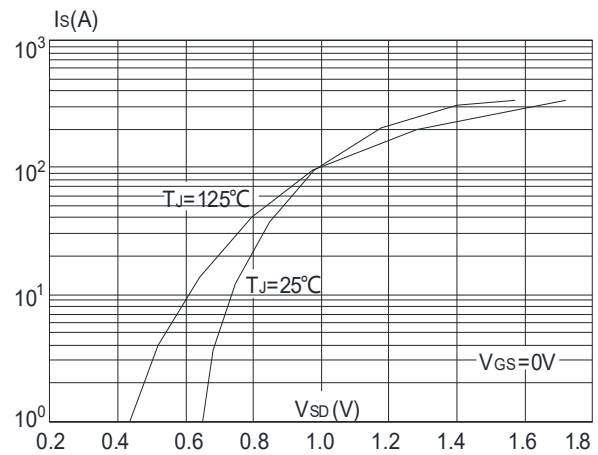


Figure 4: Body Diode Characteristics

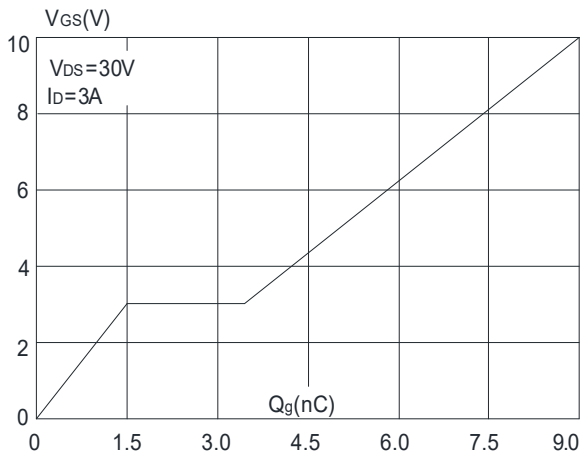


Figure 5: Gate Charge Characteristics

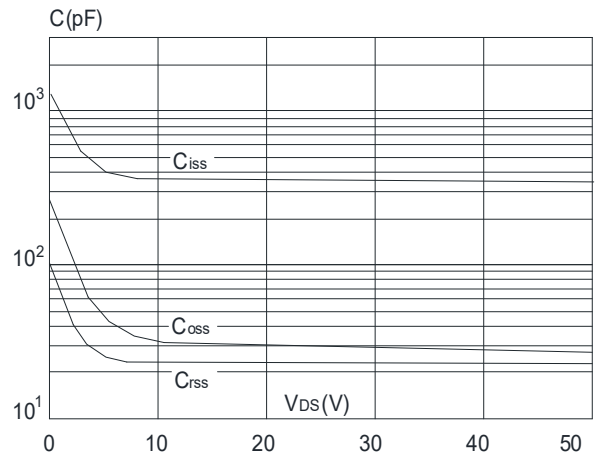
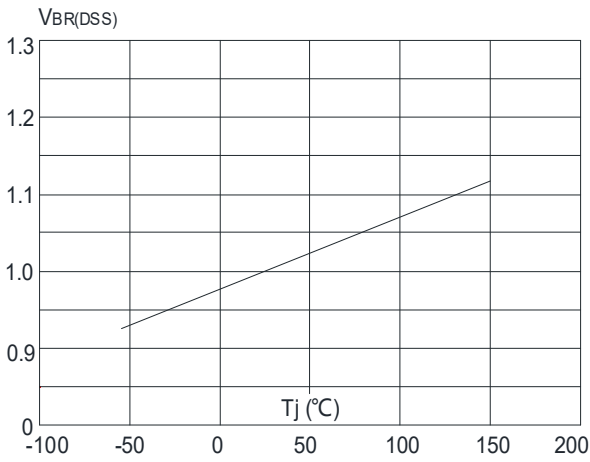
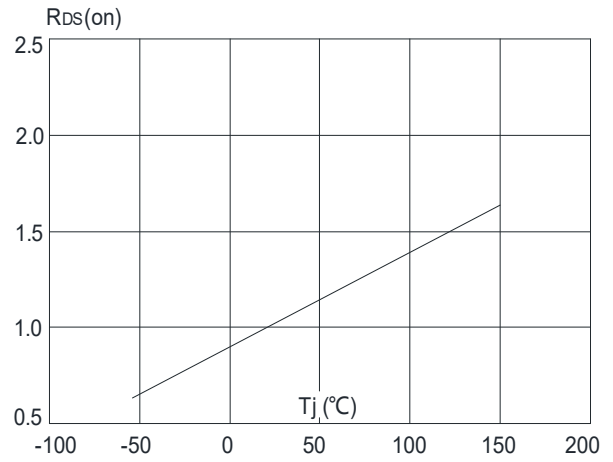


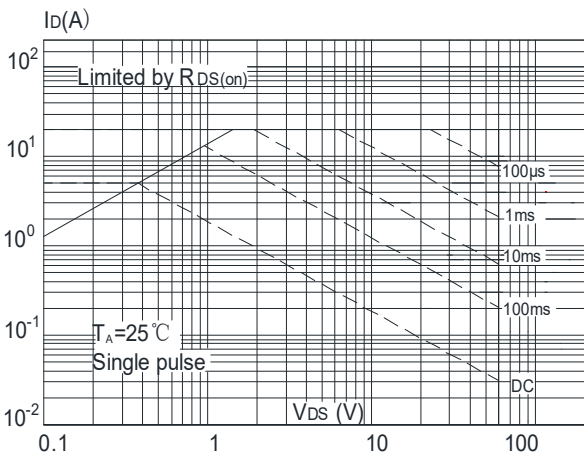
Figure 6: Capacitance Characteristics



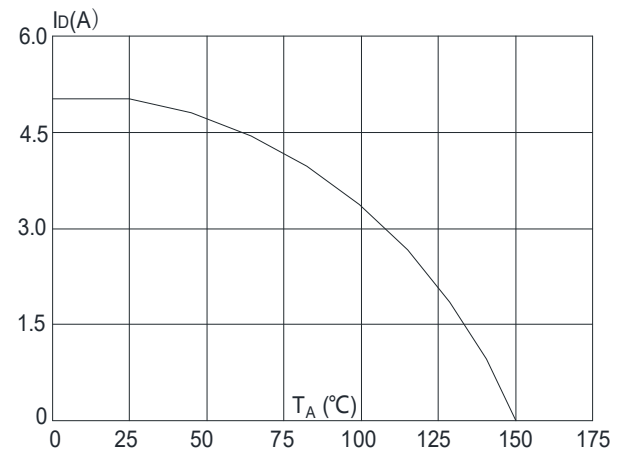
**Figure 7:** Normalized Breakdown Voltage vs. Junction Temperature



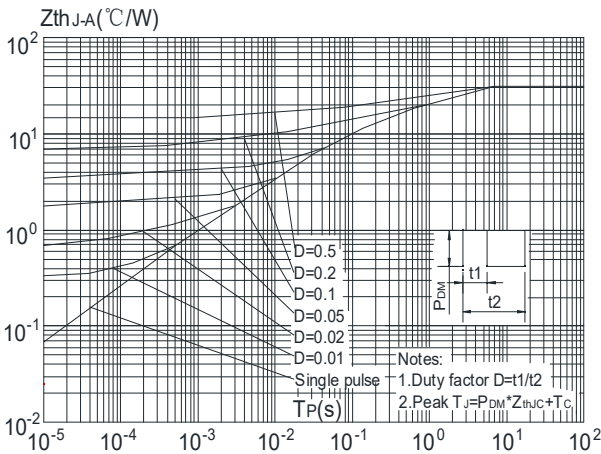
**Figure 8:** Normalized on Resistance vs. Junction Temperature



**Figure 9:** Maximum Safe Operating Area



**Figure 10:** Maximum Continuous Drain Current vs. Ambient Temperature



**Figure.11:** Maximum Effective Transient Thermal Impedance, Junction-to-Ambient





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